74ALVC16245; 74ALVCH16245

16-bit transceiver with direction pin; 3-state

Rev. 4 — 21 November 2017 Product data sheet

1 General description

The 74ALVC16245; 74ALVCH16245 is a 16-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions.

The 74ALVC16245; 74ALVCH16245 features two output enable inputs (pins $n\overline{OE}$) for easy cascading and two send or receive inputs (pins nDIR) for direction control. Pins $n\overline{OE}$ control the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74ALVCH16245 has an active bushold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

2 Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimize noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bushold (74ALVCH16245 only)
- Output drive capability 50 Ω transmission lines at 85 °C
- Current drive ±24 mA at V_{CC} = 3.0 V.
- Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
  - CDM JESD22-C101E exceeds 1000 V

3 Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74ALVC16245DL	-40 °C to +85 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1
74ALVCH16245DL				
74ALVC16245DGG	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1
74ALVCH16245DGG				

4 Functional diagram

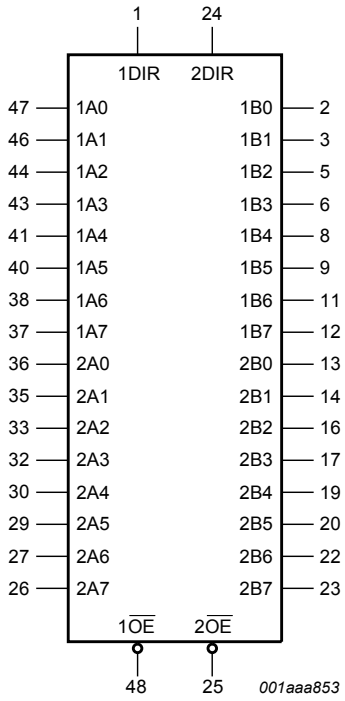


Figure 1. Logic symbol

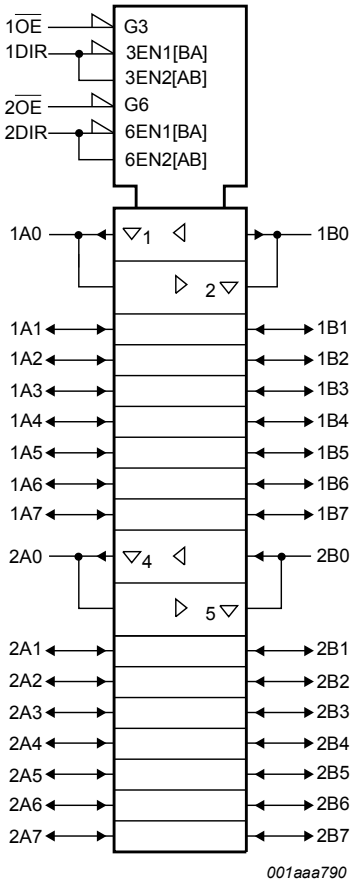


Figure 2. IEC logic symbol

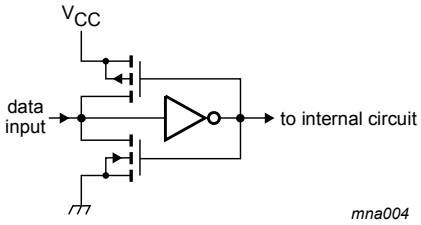


Figure 3. Bushold circuit

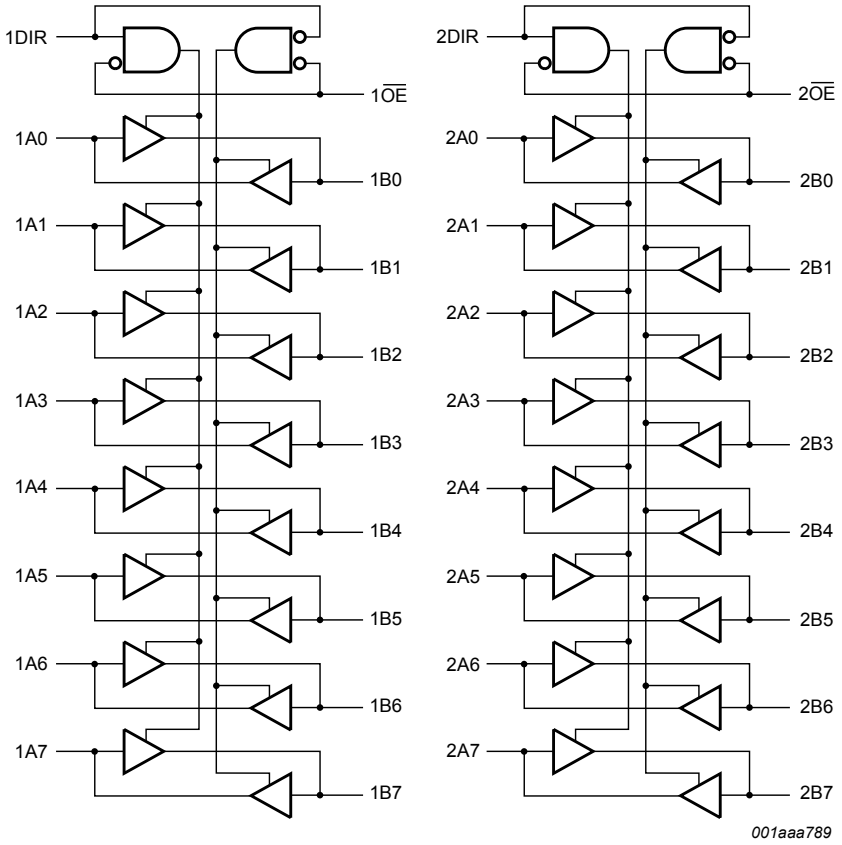


Figure 4. Logic diagram

5 Pinning information

5.1 Pinning

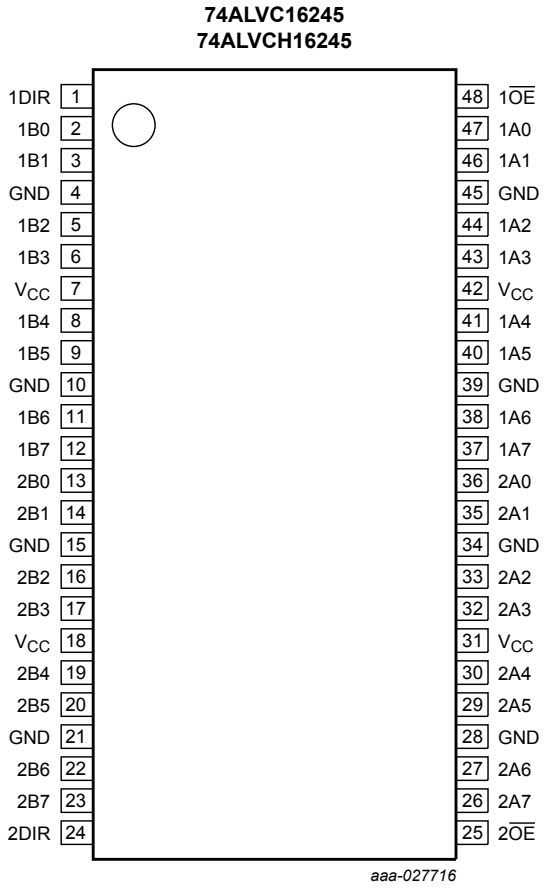


Figure 5. Pin configuration (T)SSOP48

5.2 Pin description

Table 2. Pin description

Pin	Symbol	Description
1, 24	1DIR, 2DIR	direction control inputs
2, 3, 5, 6, 8, 9, 11, 12	1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	data output or input
4, 10, 15, 21, 28, 34, 39, 45	GND	ground (0 V)
7, 18, 31, 42	V_{CC}	positive supply voltage
13, 14, 16, 17, 19, 20, 22, 23	2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	data output or input
48, 25	$1\overline{OE}$, $2\overline{OE}$	output enable input (active LOW)
36, 35, 33, 32, 30, 29, 27, 26	2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	data input or output
47, 46, 44, 43, 41, 40, 38, 37	1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	data input or output

6 Functional description

Table 3. Function table [1]

Input		Input or output	
$n\overline{OE}$	**nDIR**	**nAn**	**nBn**
L	L	output nAn = nBn	input
L	H	input	output nBn = nAn
H	X	Z	Z

[1] H = HIGH voltage level
L = LOW voltage level
X = don't care
Z = high-impedance OFF-state.

7 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+4.6	V
V_I	input voltage	data inputs with bushold	[1]	-0.5	V_{CC} + 0.5	V
		data inputs without bushold	[1]	-0.5	+4.6	V
		control pins	[1]	-0.5	+4.6	V
V_O	output voltage		[1]	-0.5	V_{CC} + 0.5	V
I_{IK}	input clamping current	V_I < 0 V		-50	-	mA
I_{OK}	output clamping current	V_O > V_{CC} or V_O < 0 V		-	±50	mA
I_O	output current	V_O = 0 V to V_{CC}		-	±50	mA
I_{CC}	supply current			-	100	mA
I_{GND}	ground current			-100	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +85 °C				
		SSOP package	[2]	-	850	mW
		TSSOP package	[3]	-	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] Above 55 °C the value of P_{tot} derates linearly with 11.3 mW/K.
[3] Above 55 °C the value of P_{tot} derates linearly with 8 mW/K.

8 Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage	maximum speed performance				
		C_L = 30 pF	2.3	-	2.7	V
		C_L = 50 pF	3.0	-	3.6	V
		low-voltage applications	1.2	-	3.6	V
V_I	input voltage		0	-	V_{CC}	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 3.0 V	-	-	20	ns/V
		V_{CC} = 3.0 V to 3.6 V	-	-	10	ns/V

9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	1.5	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 2.3 V to 2.7 V	-	1.2	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	1.5	0.8	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = -100 µA; V_{CC} = 2.3 V to 3.6 V	V_{CC} - 0.2	V_{CC}	-	V
		I_O = -6 mA; V_{CC} = 2.3 V	V_{CC} - 0.3	V_{CC} - 0.08	-	V
		I_O = -12 mA; V_{CC} = 2.3 V	V_{CC} - 0.6	V_{CC} - 0.26	-	V
		I_O = -12 mA; V_{CC} = 2.7 V	V_{CC} - 0.5	V_{CC} - 0.14	-	V
		I_O = -12 mA; V_{CC} = 3.0 V	V_{CC} - 0.6	V_{CC} - 0.09	-	V
		I_O = -24 mA; V_{CC} = 3.0 V	V_{CC} - 1.0	V_{CC} - 0.28	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 100 µA; V_{CC} = 2.3 V to 3.6 V	-	GND	0.20	V
		I_O = 6 mA; V_{CC} = 2.3 V	-	0.07	0.40	V
		I_O = 12 mA; V_{CC} = 2.3 V	-	0.15	0.70	V
		I_O = 12 mA; V_{CC} = 2.7 V	-	0.14	0.40	V
		I_O = 24 mA; V_{CC} = 3.0 V	-	0.27	0.55	V
I_I	input leakage current	V_{CC} = 2.3 V to 3.6 V; V_I = V_{CC} or GND	-	0.1	5	µA
I_{OZ}	OFF-state output current	V_{CC} = 2.3 V to 3.6 V; V_I = V_{IH} or V_{IL}; V_O = V_{CC} or GND	-	0.1	10	µA

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
I_{CC}	supply current	V_{CC} = 2.3 V to 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.2	40	µA
ΔI_{CC}	additional supply current	74ALVCH16245; per data I/O pin; V_{CC} = 2.3 V to 3.6 V; V_I = V_{CC} - 0.6 V; I_O = 0 A	-	150	750	µA
I_{BHL}	bus hold LOW current	V_{CC} = 2.3 V; V_I = 0.7 V [2]	45	-	-	µA
		V_{CC} = 3.0 V; V_I = 0.8 V [2]	75	150	-	µA
I_{BHH}	bus hold HIGH current	V_{CC} = 2.3 V; V_I = 1.7 V [2]	-45	-	-	µA
		V_{CC} = 3.0 V; V_I = 2.0 V [2]	-75	-175	-	µA
I_{BHLO}	bus hold LOW overdrive current	V_{CC} = 3.6 V [2]	500	-	-	µA
I_{BHHO}	bus hold HIGH overdrive current	V_{CC} = 3.6 V [2]	-500	-	-	µA
C_I	input capacitance		-	4.0	-	pF
$C_{I/O}$	input/output capacitance		-	8.0	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.
[2] Valid for data inputs of bushold parts.

10 Dynamic characteristics

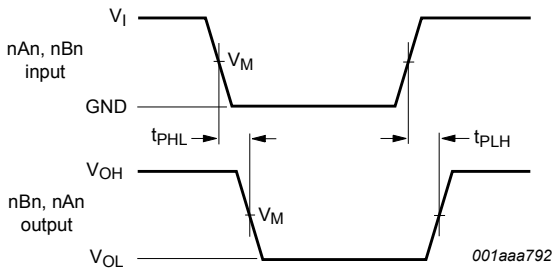
Table 7. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
T_{amb} = -40 °C to +85 °C							
t_{pd}	propagation delay	nAn to nBn; nBn to nAn; see Figure 6	[2]				
		V_{CC} = 2.3 V to 2.7 V		1.0	2.0	3.7	ns
		V_{CC} = 2.7 V		1.0	2.1	3.6	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	1.9	3.0	ns
t_{en}	enable time	$n\overline{OE}$ to nAn; $n\overline{OE}$ to nBn; see Figure 7	[3]				
		V_{CC} = 2.3 V to 2.7 V		1.0	2.7	5.7	ns
		V_{CC} = 2.7 V		1.0	3.0	5.4	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.3	4.4	ns
t_{dis}	disable time	$n\overline{OE}$ to nAn; $n\overline{OE}$ to nBn; see Figure 7	[4]				
		V_{CC} = 2.3 V to 2.7 V		1.0	2.2	5.2	ns
		V_{CC} = 2.7 V		1.0	3.1	4.6	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.8	4.1	ns
C_{PD}	power dissipation capacitance	per buffer; V_I = GND to V_{CC}	[5]				
		outputs enabled		-	29	-	pF
		outputs disabled		-	5	-	pF

[1] Typical values are measured at T_{amb} = 25 °C
Typical values for V_{CC} = 2.3 V to 2.7 V are measured at V_{CC} = 2.5 V.
Typical values for V_{CC} = 3.0 V to 3.6 V are measured at V_{CC} = 3.3 V.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.
[3] t_{en} is the same as t_{PZL} and t_{PZH}.
[4] t_{dis} is the same as t_{PLZ} and t_{PHZ}.
[5] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in Volts;
N = total load switching outputs;
$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

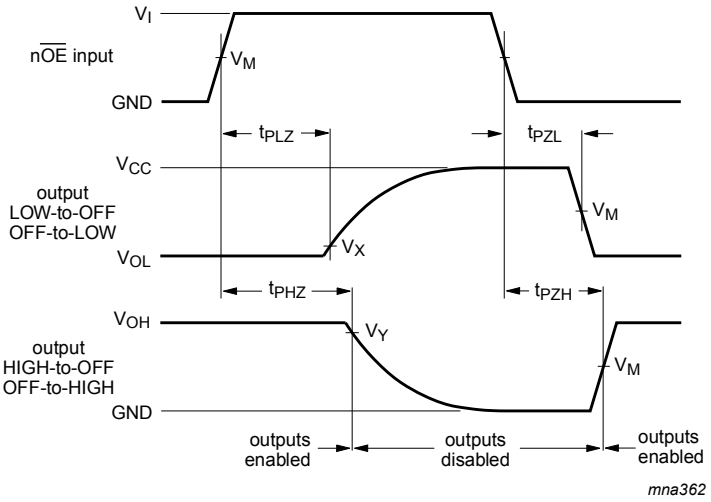
10.1 Waveforms and test circuit



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 6. Input (nAn, nBn) to output (nBn, nAn) propagation delay times



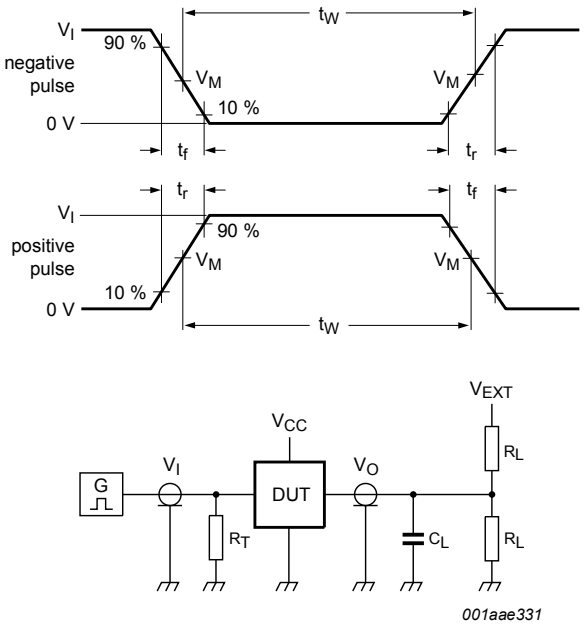
Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 7. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
< 2.7 V	0.5 × V_{CC}	0.5 × V_{CC}	V_{OL} + 0.15 V	V_{OH} - 0.15 V
≥ 2.7 V	1.5 V	1.5 V	V_{OL} + 0.3 V	V_{OH} - 0.3 V



Test data is given in Table 9.

Definitions test circuit:

R_L = Load resistance.

C_L = Load capacitance includes jig and probe capacitance.

R_T = Termination resistance should be equal to Z_o of pulse generator.

V_{EXT} = Test voltage for switching times.

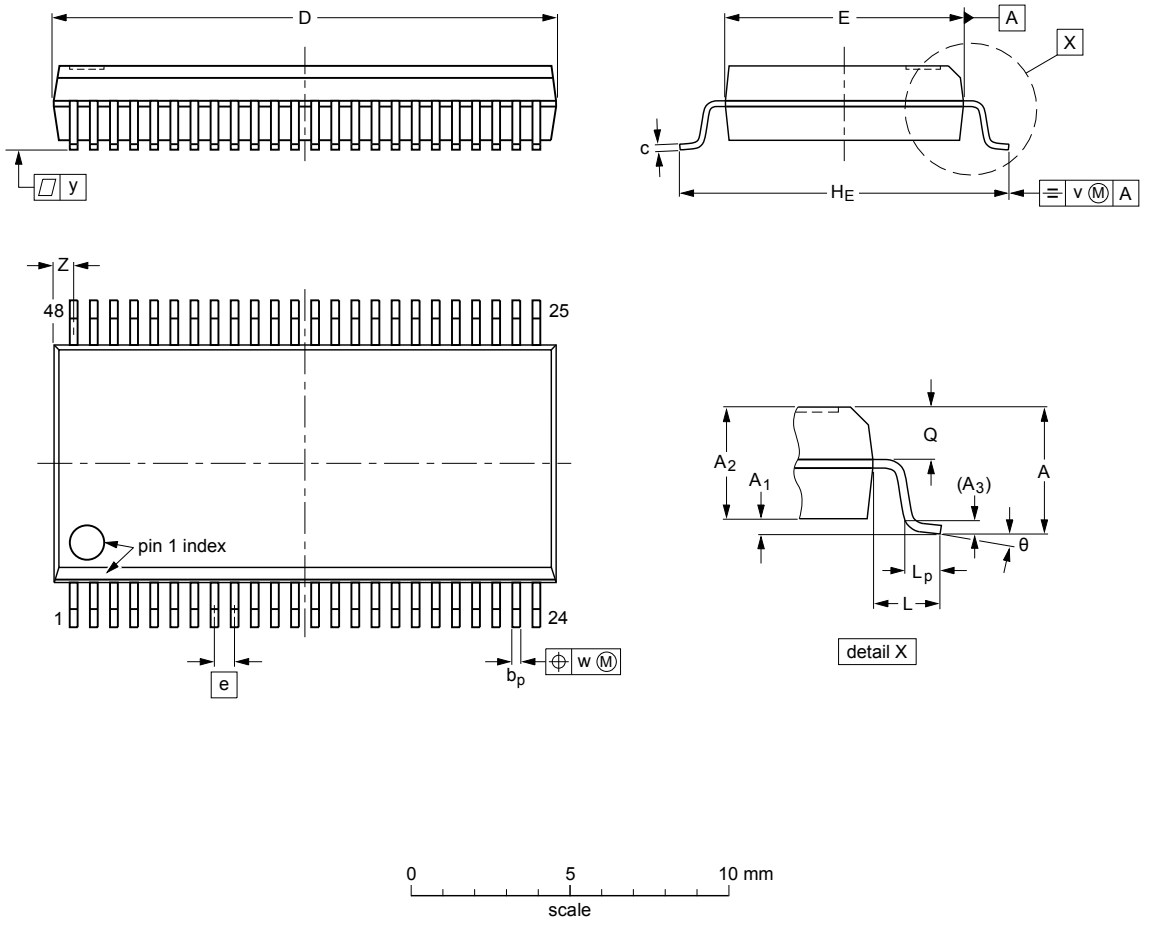
Figure 8. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PHZ}, t_{PZH}	t_{PLZ}, t_{PZL}
< 2.7 V	V_{CC}	≤2.0 ns	30 pF	500 Ω	open	GND	2 × V_{CC}
2.7 V to 3.6 V	2.7 V	≤2.5 ns	50 pF	500 Ω	open	GND	2 × V_{CC}

11 Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm **SOT370-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

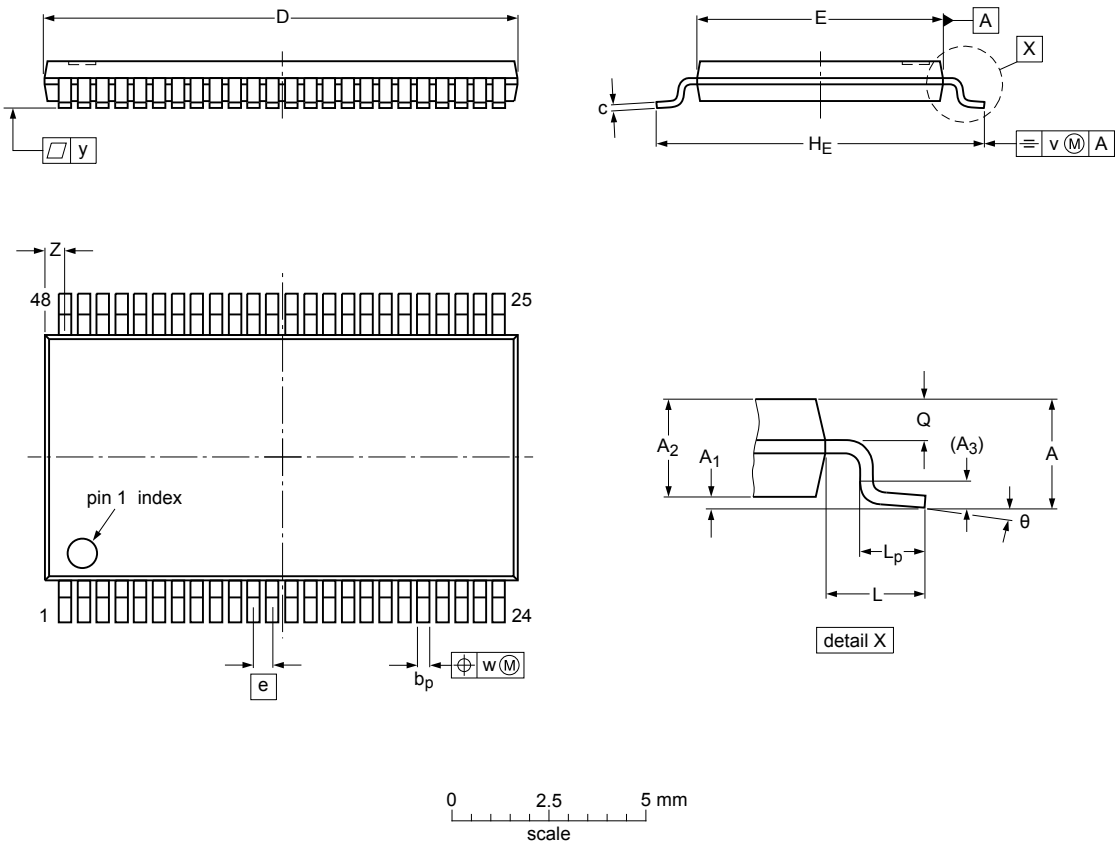
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT370-1		MO-118				~~99-12-27~~ 03-02-19

Figure 9. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm **SOT362-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	Z	θ
mm	max	1.2	0.15	1.05	0.25	0.28	0.2	12.6	6.2	0.5	8.3	1	0.8	0.50	0.25	0.08	0.1	0.8	8°
	nom																		
	min		0.05	0.85		0.17	0.1	12.4	6.0		7.9		0.4	0.35				0.4	0°

Note
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

sot362-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT362-1		MO-153				~~03-02-19~~ 13-08-05

Figure 10. Package outline SOT362-1 (TSSOP48)

12 Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

13 Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVC_ALVCH16245 v.4	20171121	Product data sheet	-	74ALVC_ALVCH16245 v.3
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate.			
74ALVC_ALVCH16245 v.3	20040512	Product data sheet	-	74ALVCH16245 v.2 74ALVC16245_ 74ALVCH16245 v.1
Modifications:	• The format of this data sheet has been redesigned to comply with the current presentation and information standard of Philips Semiconductors. • Section 1: General description updated.			
74ALVCH16245 v.2	19980629	Product specification	-	74ALVCH16245 v.1
74ALVC16245_ 74ALVCH16245 v.1	19980325	Product specification	-	-
74ALVCH16245 v.1	19950102	Preliminary specification	-	-

14 Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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